

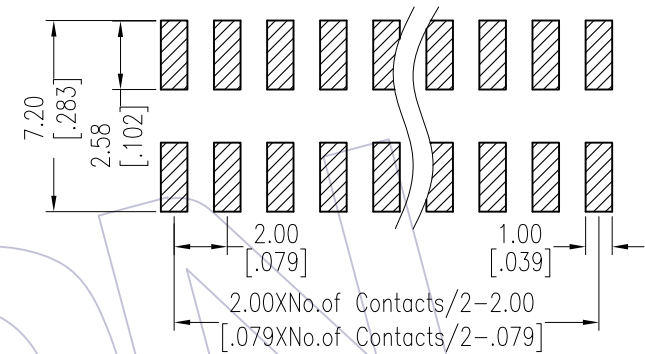
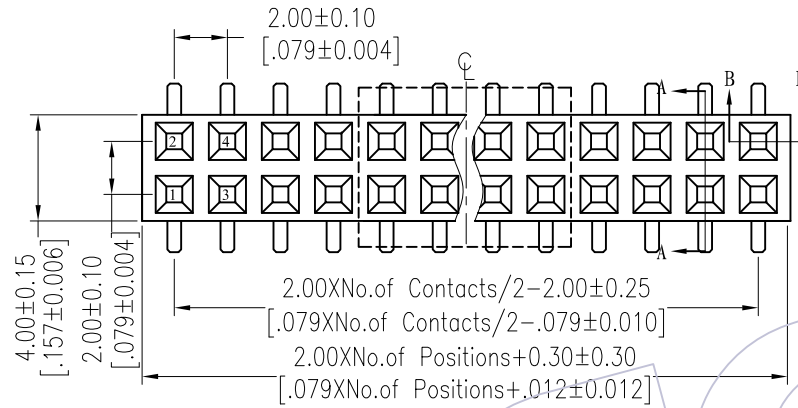
# HSF

NOTES:  
 Current Rating: 2.0AMP  
 Contact Resistance: 20mΩ Max  
 Withstand Voltage: 500V AC/DC  
 Insulation Resistance: 1000MΩ Min  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au Or Sn over Ni  
 Insulator Material: LCP+30%G.F UL94V-0



Recommended P.C.B Layout (Top Side)  
 (PCB BOARD TOLERANCE ±0.05)



## Ordering Information

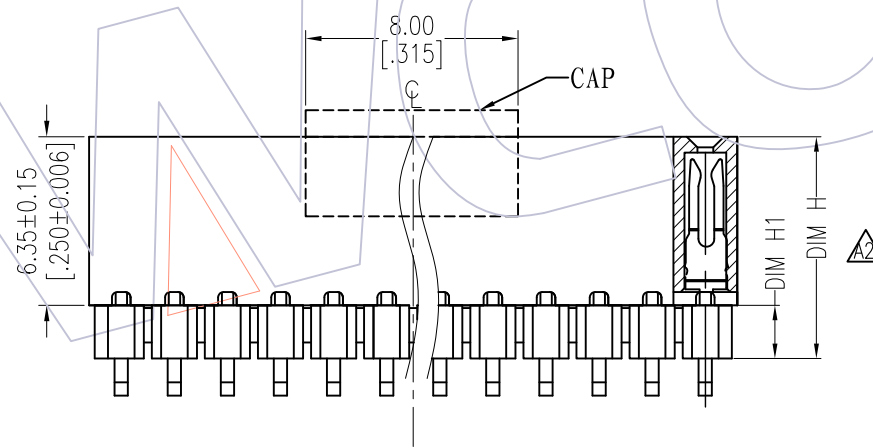
2263D - 2 XX M XX D Y N X X

No. of Pins per ROW: 02-40PIN

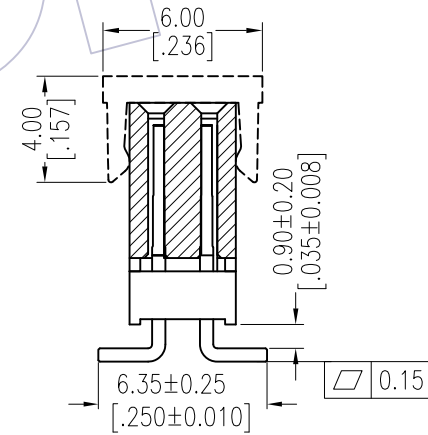
Contact Plating:  
 G0=Gold Flash  
 G3=10μ"Gold  
 G4=15μ"Gold  
 G5=30μ"Gold  
 S0=Gold Flash/Tin  
 S3=10μ"Gold/Tin  
 S4=15μ"Gold/Tin  
 S5=30μ"Gold/Tin  
 SN=Tin  
 SM=Matte Tin

Insulator:  
 D=LCP

Packing:  
 T=Tube  
 P=Tube+CAP  
 R=Tape&Reel+CAP



SECTION B-B



SECTION A-A

DIMENSION ANTITHESSES LIST		
H1XN(N≤4)	DIM H	DIM H1
STANDARD		2.00
ALTERNATE		

Item	Pitch	Mating
Standard	2.00	1215/1220
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A2	2015/02/06	Modify drawing	-----	x.x ±0.40	Wang	2015/02/06	UNIT	mm	2263D-2XXMXXDYNXX
A1	2013/04/26	Modify drawing	-----	x.xx ±0.25	CHECK	DATE	SIZE	A4	TITLE: FH2.00mm DUAL ROW 180° SMT H=6.35
A0	2012/07/23	NEW	-----	x.xxx ±0.15	APPROVE	DATE	SHEET	1/1	Customer NO.
				Angle ± 3'			PROJ.		
				DIM TOL					